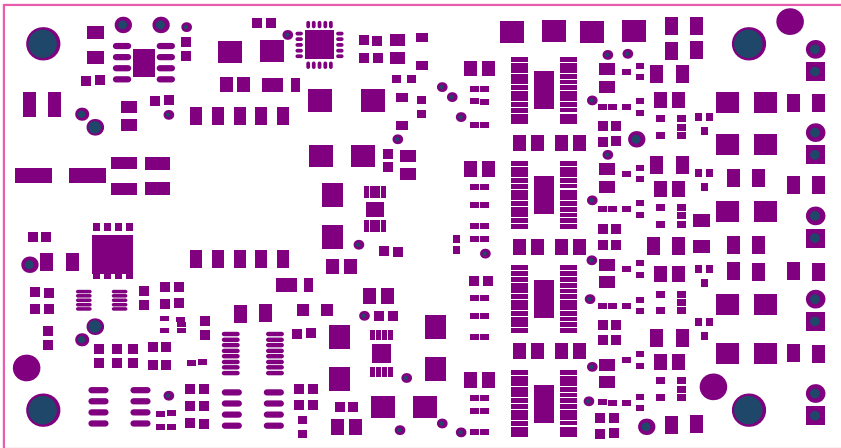
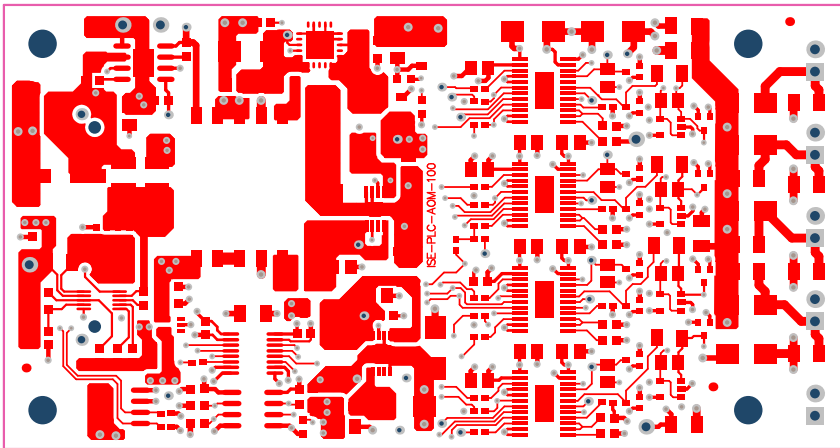


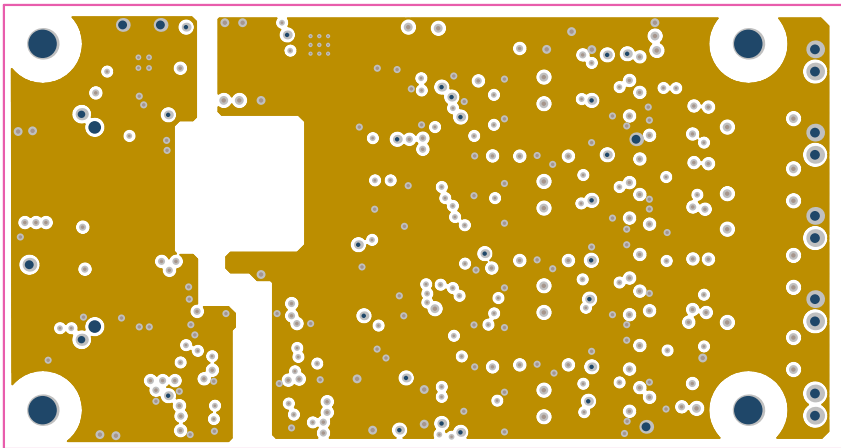
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 1/16/2014 9:13:29 PM	TEXAS INSTRUMENTS	



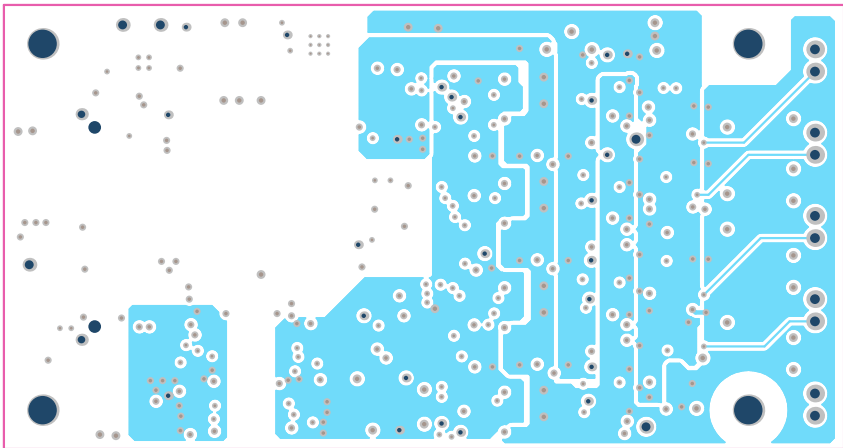
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 1/16/2014 9:13:29 PM	TEXAS INSTRUMENTS	



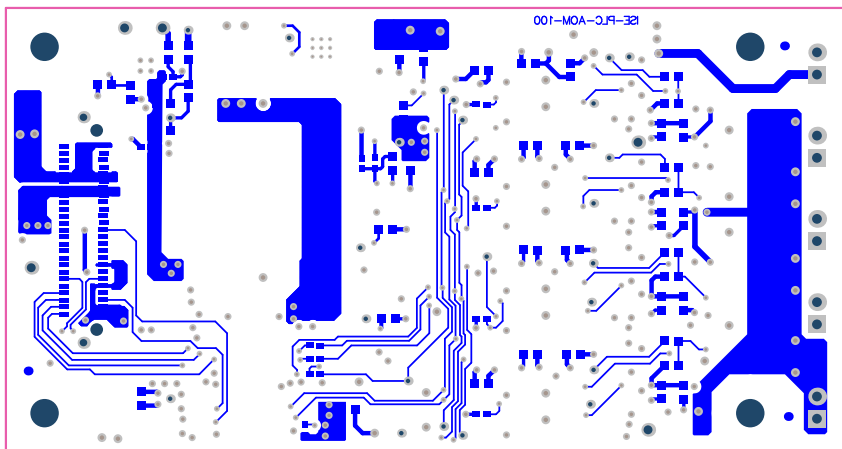
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer			
PLOT NAME = Top Layer	GENERATED : 1/16/2014 9:13:30 PM	TEXAS INSTRUMENTS	



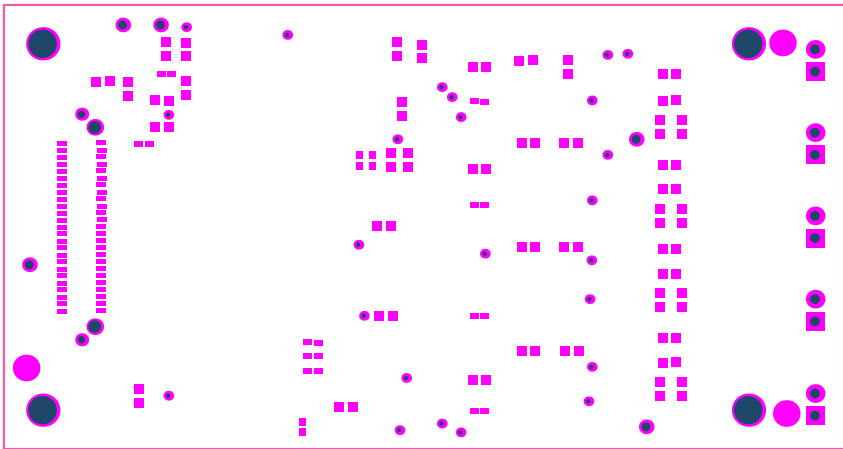
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = P1_GNDPLANE			
PLOT NAME = P1_GNDPLANE	GENERATED : 1/16/2014 9:13:31 PM	TEXAS INSTRUMENTS	



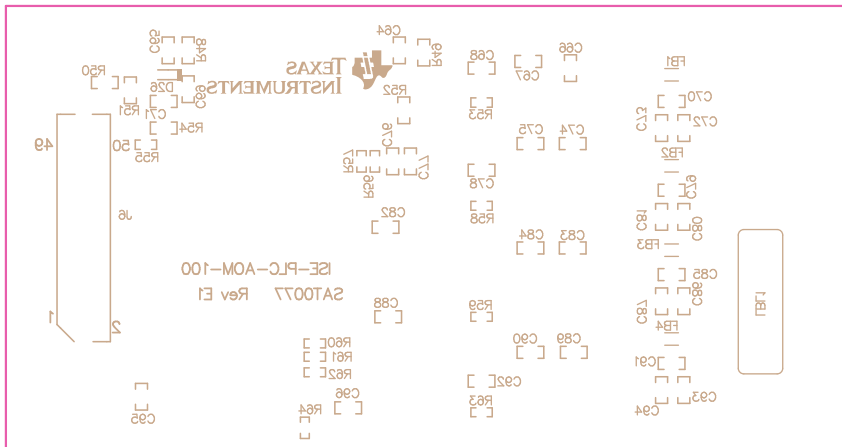
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = P2_PWRPLANE			
PLOT NAME = P2_PWRPLANE	GENERATED : 1/16/2014 9:13:31 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer			
PLOT NAME = Bottom Layer	GENERATED : 1/16/2014 9:13:32 PM	TEXAS INSTRUMENTS	

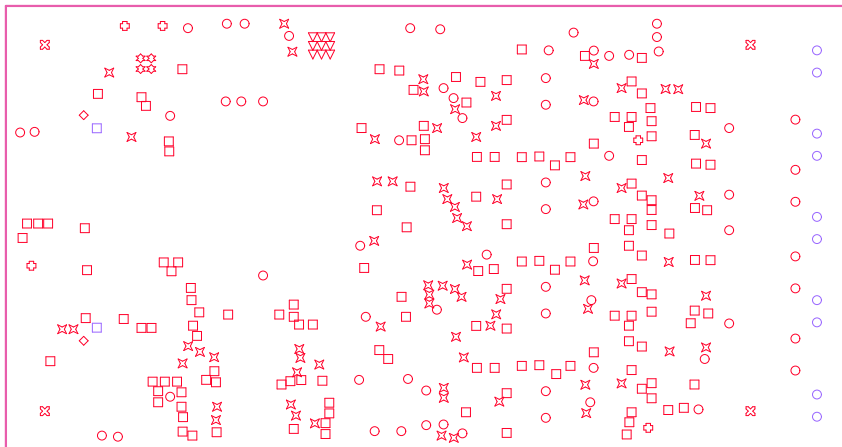


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 1/16/2014 9:13:33 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 1/16/2014 9:13:33 PM	TEXAS INSTRUMENTS	

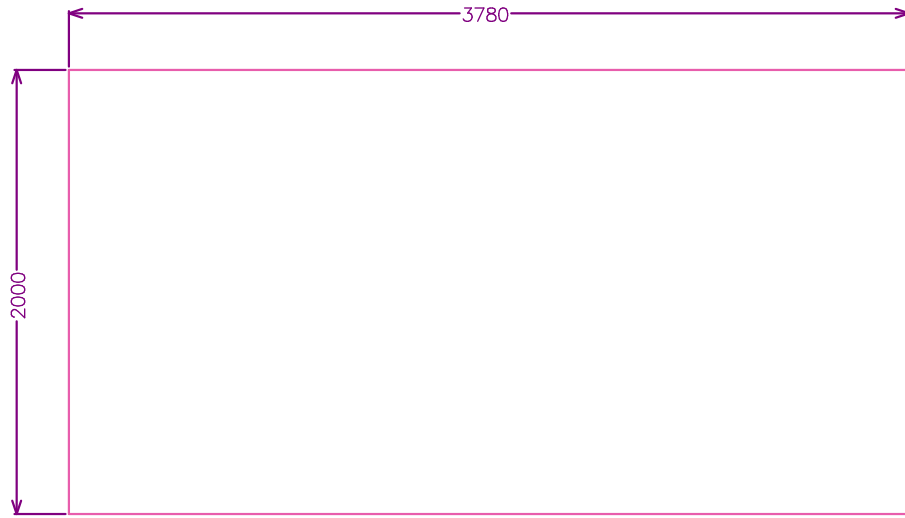




Symbol	Hit Count	Tool Size	Plated	Hole Type
▽	9	7.874mil (0.2mm)	PTH	Round
×	75	12mil (0.305mm)	PTH	Round
☆	4	12.992mil (0.33mm)	PTH	Round
□	159	16mil (0.406mm)	PTH	Round
○	68	20mil (0.508mm)	PTH	Round
◇	2	33mil (0.838mm)	PTH	Round
⊕	5	40mil (1.016mm)	PTH	Round
○	10	44mil (1.118mm)	PTH	Round
□	2	57.087mil (1.45mm)	NPTH	Round
⊗	4	128mil (3.251mm)	NPTH	Round
	338 Total			

Drill Table

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 1/16/2014 9:13:34 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: SAT0077	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 1/16/2014 9:13:34 PM	TEXAS INSTRUMENTS	

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